

[54] DUAL MODULAR JACK ADAPTER

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[73] Assignee: The Siemon Company, Watertown, Conn.

[\*\*] Term: 14 Years

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[52] U.S. Cl. .... D13/147

[58] Field of Search ..... D13/133, 134, 135, 136, D13/140-147, 139, 152, 154, 137, 138; 439/554, 344, 699, 619, 628, 676, 668, 571, 418, 416, 391

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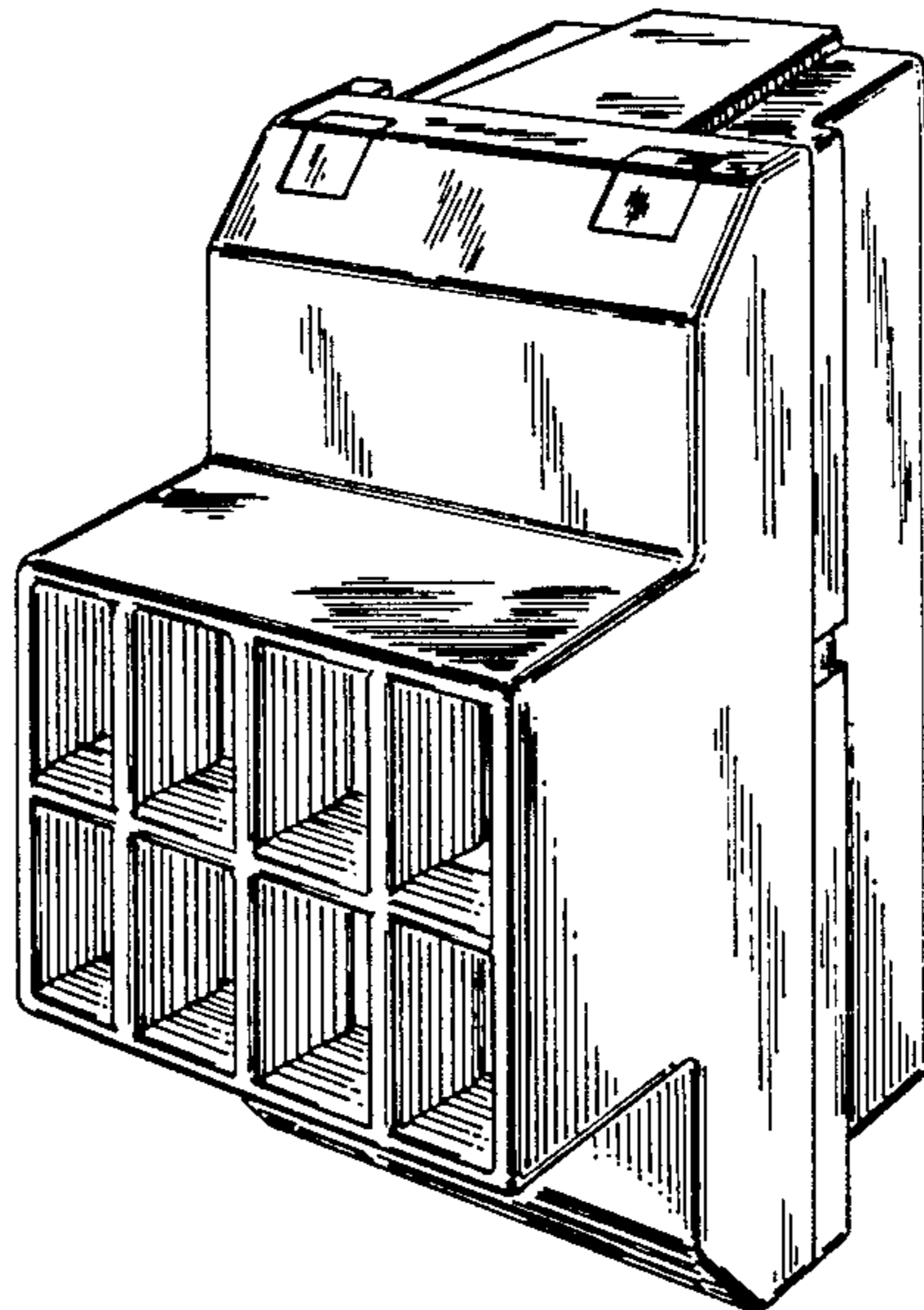
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[57] CLAIM

The ornamental design for a dual modular jack adapter, as shown and described.

DESCRIPTION

FIG. 1 is a top, front, right side perspective view of a dual modular jack adapter showing our new design; FIG. 2 is a bottom, rear, right side perspective view thereof on a reduced scale; FIG. 3 is a rear elevation view thereof; FIG. 4 is a right side elevational view thereof, the left side being a mirror image; FIG. 5 is a top plan view thereof, the bottom being a mirror image; FIG. 6 is a front elevation thereof.



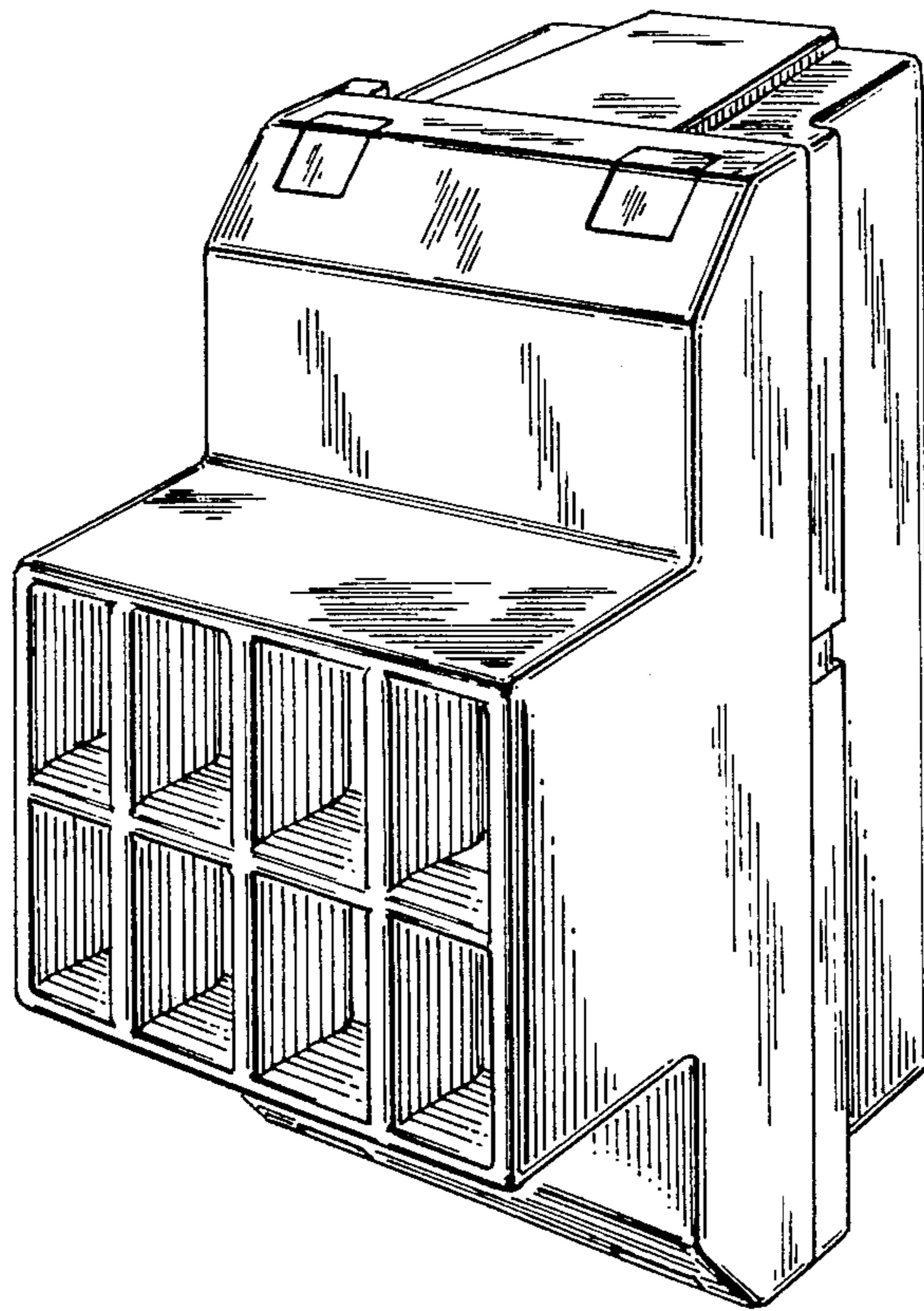


FIG. 1

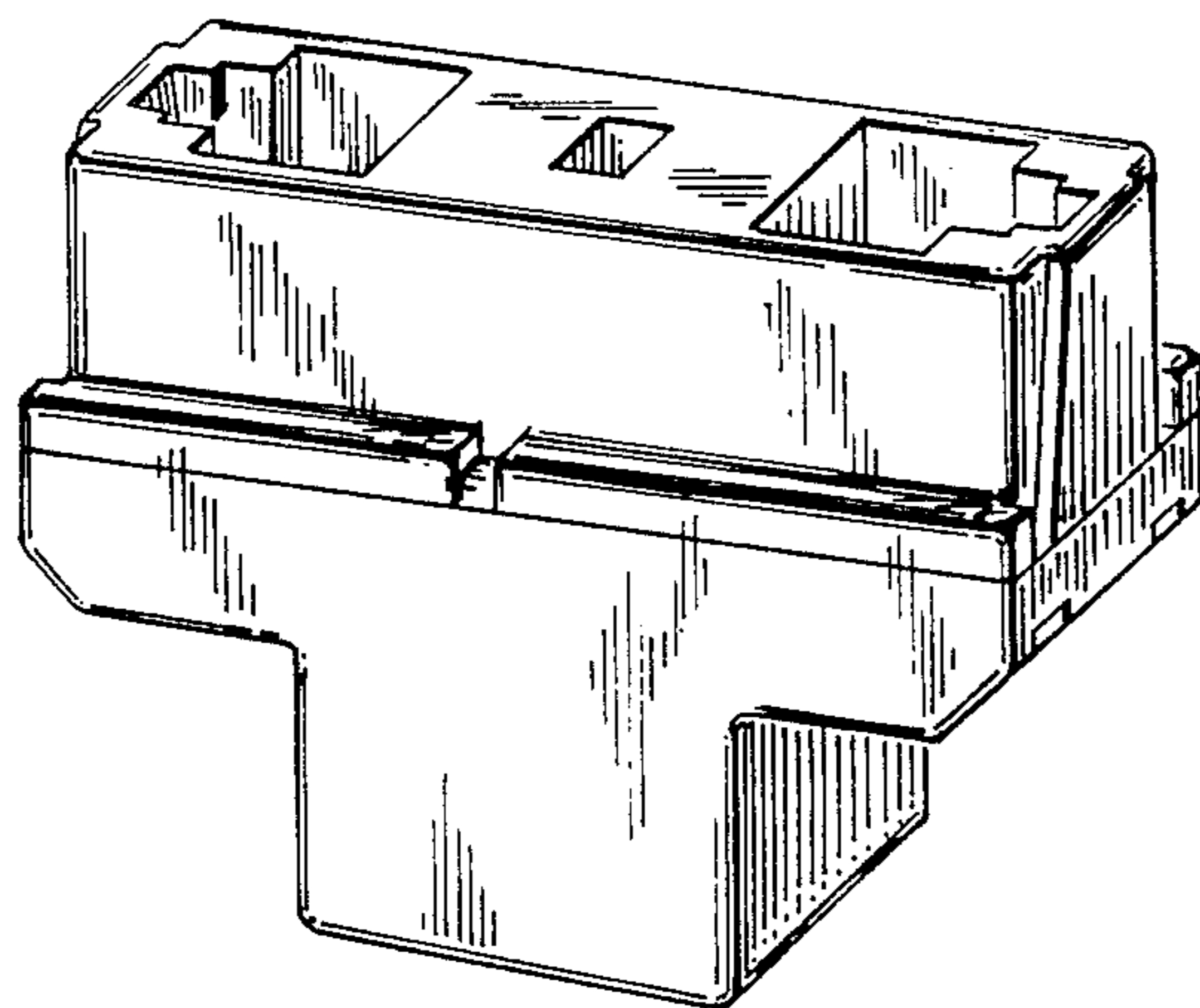


FIG. 2

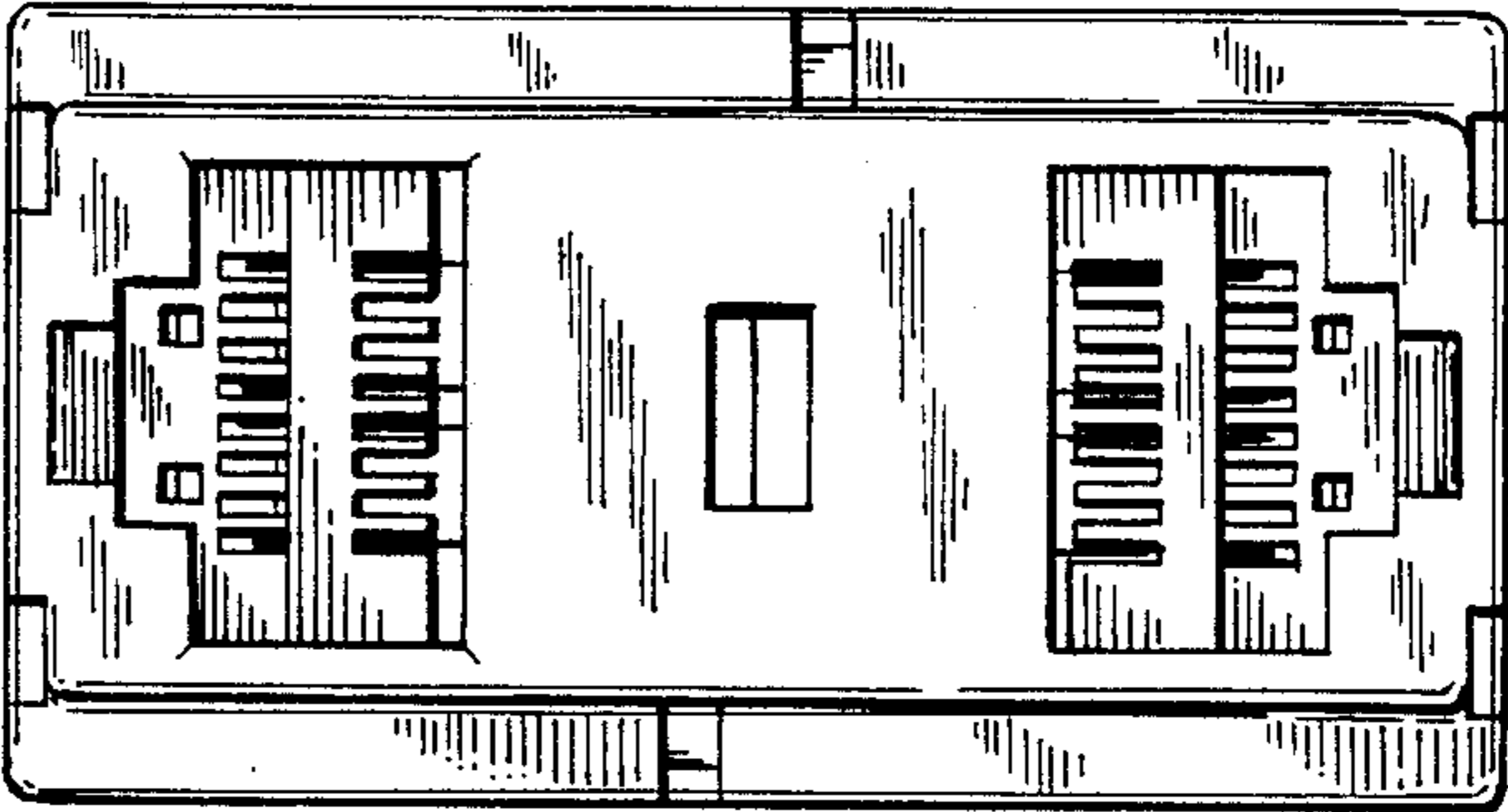


FIG. 3

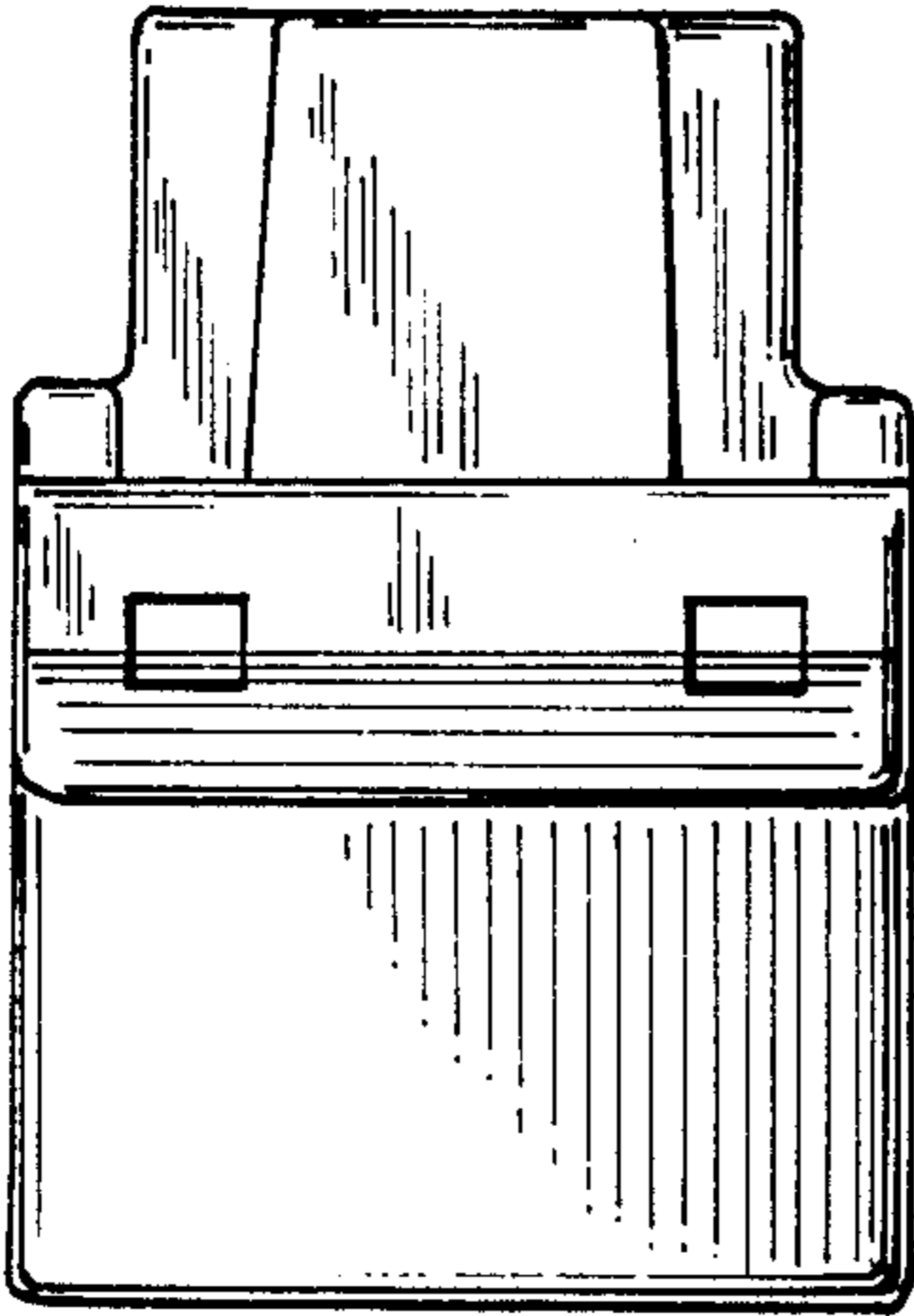


FIG. 5

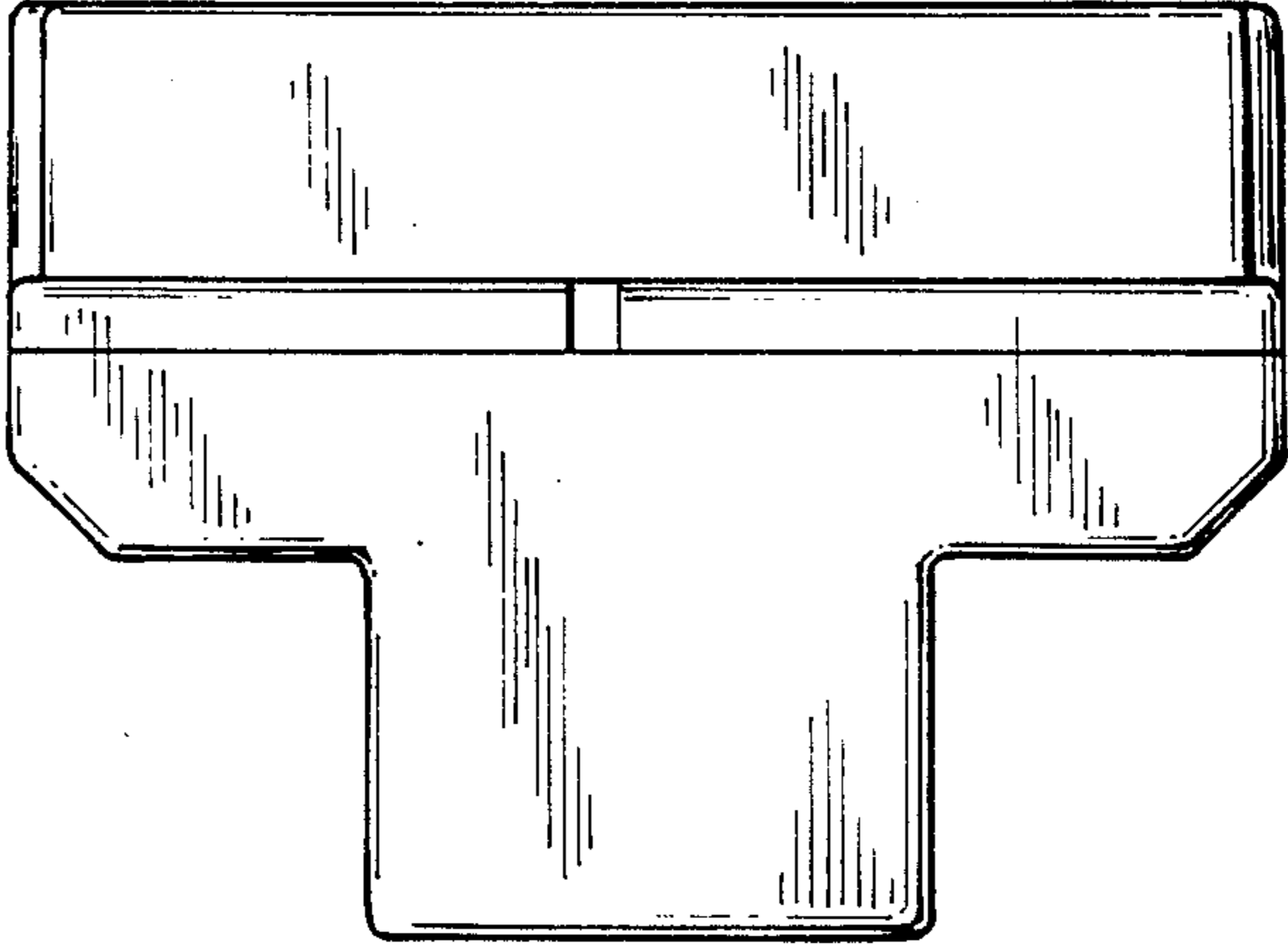


FIG. 4

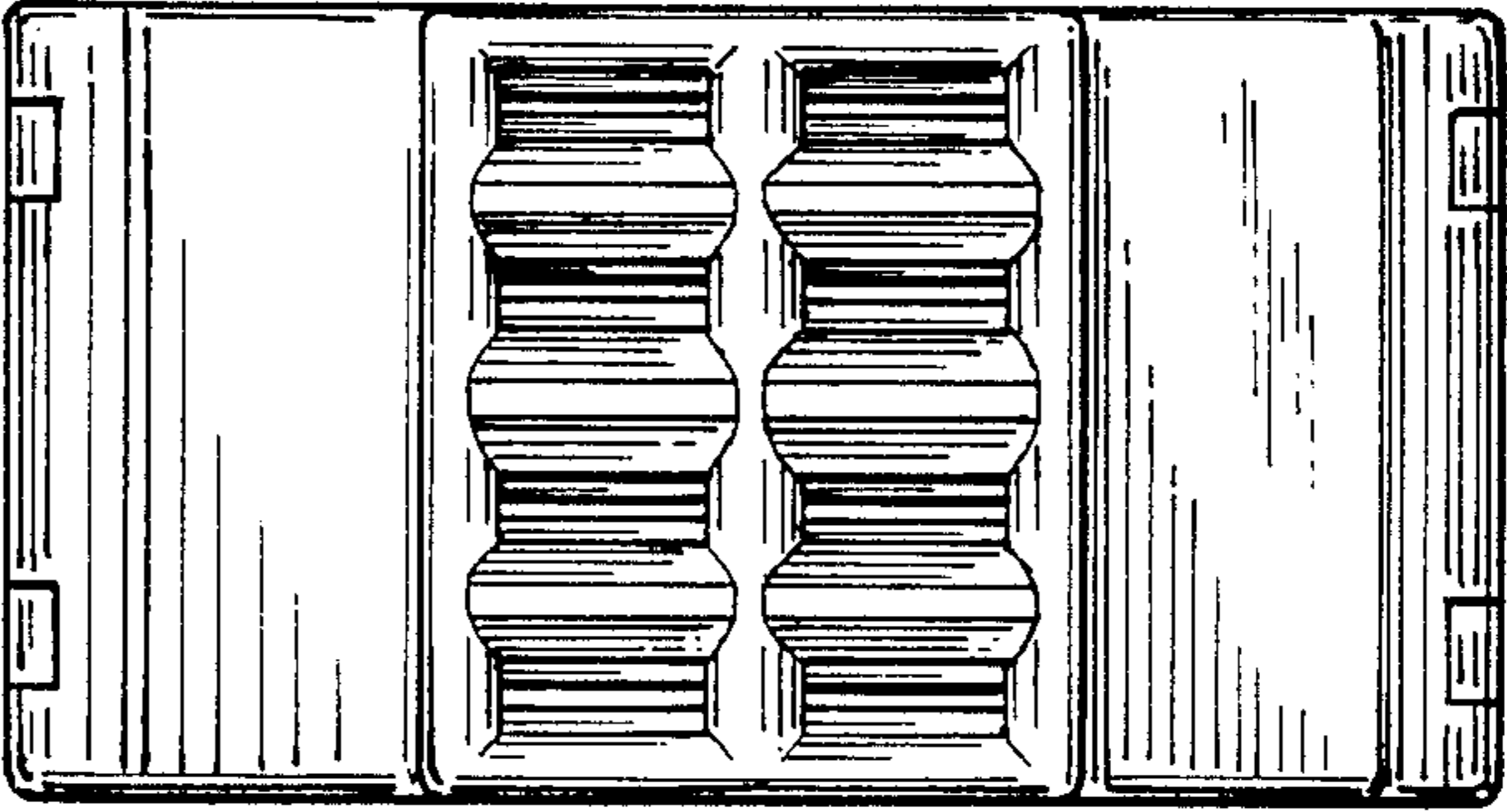


FIG. 6